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NDS0605 P-Channel Enhancement Mode Field Effect Transistor

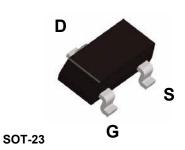
General Description

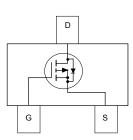
These P-Channel enhancement mode field effect transistors are produced using ON Semiconductor's proprietary, high cell density, DMOS technology. This very high density process has been designed to minimize on-state resistance, provide rugged and reliable performance and fast switching. They can be used, with a minimum of effort, in most applications requiring up to 180mA DC and can deliver current up to 1A.

This product is particularly suited to low voltage applications requiring a low current high side switch.

Features

- -0.18A, -60V. $R_{DS(ON)}$ = 5 Ω @ V_{GS} = -10 V
- Voltage controlled p-channel small signal switch
- High density cell design for low $R_{\text{DS}(\text{ON})}$
- High saturation current





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source	ce Voltage		-60	V	
V _{GSS}	Gate-Sourc	rce Voltage		±20	V	
ID	Drain Current – Continuous (Note 1)		(Note 1)	-0.18	А	
		- Pulsed		-1		
P _D	Maximum F	Maximum Power Dissipation (Note 1)		0.36	W	
	Derate Above 25°C			2.9	mW/°C	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C		
TL	Maximum Lead Temperature for Soldering Purposes, 1/16" from Case for 10 Seconds			300	°C	
Therma	al Charac	teristics				
R _{0JA}	Thermal Resistance, Junction-to-Ambient (Note 1)		350	°C/W		
Packag	e Markin	g and Orderin	g Information			
Device Marking		Device	Reel Size	Tape width	Quantity	
65D		NDS0605	7"	8mm	3000 units	

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NDS0605

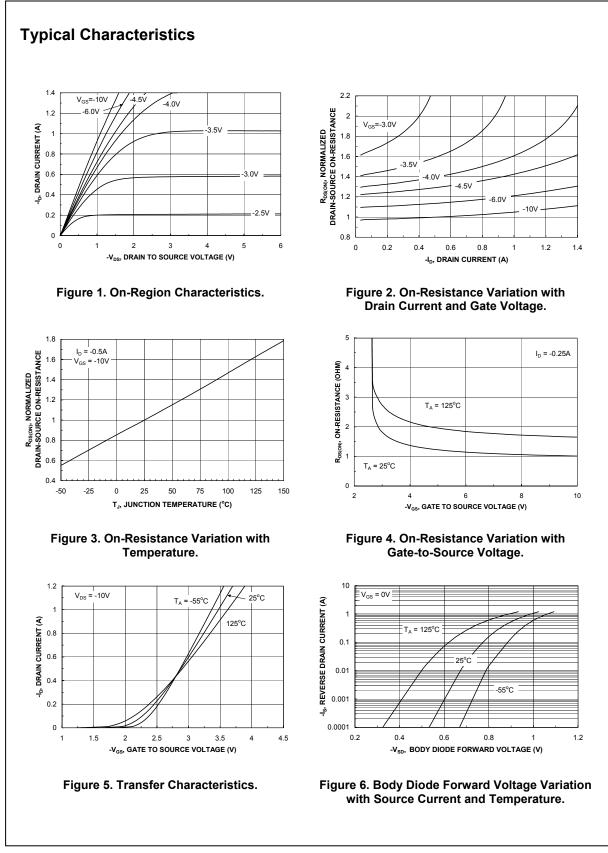
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics		I			
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -10 \mu A$	-60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = -10 µA,Referenced to 25°C		-53		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -48 V$, $V_{GS} = 0 V$			-1	μA
		$V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V} \text{ T}_{J} = 125^{\circ}\text{C}$			-500	μA
I _{GSS}	Gate–Body Leakage.	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-1	-1.7	-3	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A,Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source	$V_{GS} = -10 \text{ V}, I_D = -0.5 \text{ A}$		1.0	5.0	Ω
	On–Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -0.25 \text{ A}$		1.3	7.5	
	On–State Drain Current	$V_{GS} = -10 V, I_D = -0.5 A, T_J = 125^{\circ}C$ $V_{GS} = -10 V, V_{DS} = -10 V$	-0.6	1.7	10	A
I _{D(on)}	Forward Transconductance	$V_{DS} = -10V$, $V_{DS} = -10V$ $V_{DS} = -10V$, $I_D = -0.2 A$	0.07	0.43		S
g fs		$v_{DS} = -10v$, $i_D = -0.2 \text{ A}$	0.07	0.43		
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -25 V$, $V_{GS} = 0 V$,		79		pF
Coss	Output Capacitance	f = 1.0 MHz		10		pF
Crss	Reverse Transfer Capacitance			4		pF
R _G	Gate Resistance	V_{GS} = -15 mV, f = 1.0 MHz		10		Ω
Switchin	g Characteristics (Note 2)		÷	-		
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -25 V$, $I_D = -0.2 A$,		2.5	5	ns
t _r	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, R_{GEN} = 6 \Omega$		6.3	12.6	ns
t _{d(off)}	Turn–Off Delay Time			10	20	ns
t _f	Turn–Off Fall Time			7.5	15	ns
Q _g	Total Gate Charge	$V_{DS} = -48 V$, $I_D = -0.5 A$,		1.8	2.5	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -10 V$		0.3		nC
Q _{gd}	Gate-Drain Charge			0.4		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain–Source Diode Forward Current				_ 0.18	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_{S} = -0.5 A(Note 2)$		-0.8	-1.5	V
t _{rr}	Diode Reverse Recovery Time	$I_{F} = -0.5A$		17		nS
Q _{rr}	Diode Reverse Recovery Charge	$d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$ (Note 2)		15		nC

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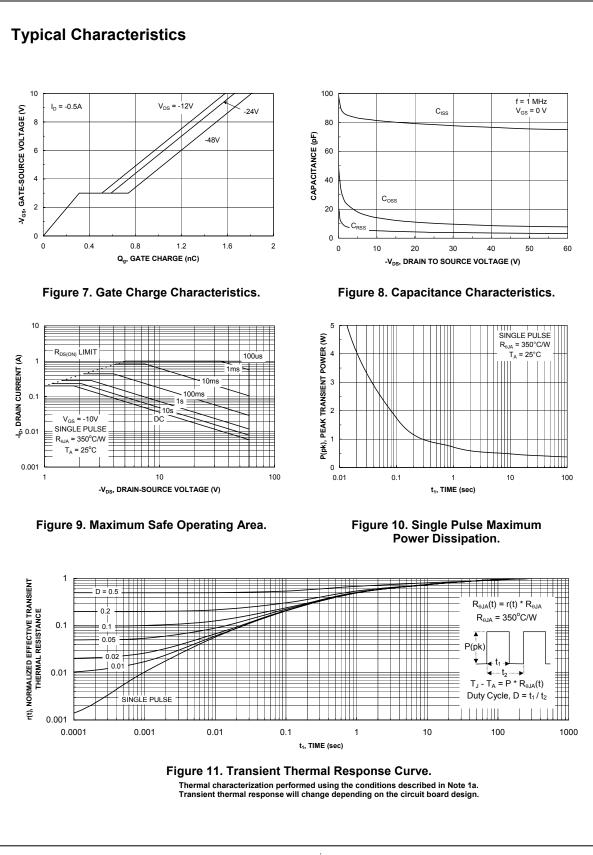
a) 350°C/W when mounted on a minimum pad..

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width $\leq 300~\mu\text{s},$ Duty Cycle $\leq 2.0\%$



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